

PATENT NUMBER

U.S. **UTILITY** Patent Application

O.I.P.E.,

PATENT DATE

SCANNED 11/5/4 Q.A

Q.A

APPLICATION NO.
09/93294

CONT/PRIOR
F

CLASS
105 438

SUBCLASS

ART UNIT
1755
2812

EXAMINER

APPLICANTS

Gaku Minamihaba
Hiroyuki Yano
Nobuyuki Kurashima
Nobuo Kawahashi

TITLE

Slurry for chemical mechanical polishing and method of manufacturing semiconductor device

PTO-2040
12/99

ISSUING CLASSIFICATION

[illegible]

☐ Continued on Issue Slip Inside File Jacket

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED		
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner)		NOTICE OF ALLOWANCE MAILED		
	<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____		ISSUE FEE <table border="1"> <tr> <td>Amount Due</td> <td>Date Paid</td> </tr> </table>		Amount Due
Amount Due	Date Paid				
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner)		ISSUE BATCH NUMBER		
WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368. Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.					

Form PTO-436A
(Rev. 6/99)

FILED WITH: ☐ DISK (CRF) ☐ FICHE ☐ CD-ROM
(Attached in pocket on right inside flap)

(FACE)